BR25G128FJ-3GE2 Information
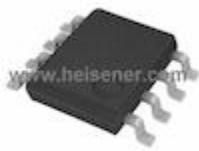
Part Number	BR25G128FJ-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Description	SPI BUS EEPROM
Package	8-SOIC (0.154", 3.90mm Width)

For Reference Only

For the pricing/inventory/lead time, please contact us
Website: https://www.heisener.com
E-mail: salesdept@heisener.com

Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.

BR25G128FJ-3GE2 Specifications

Manufacturer Part Number	BR25G128FJ-3GE2
Manufacturer	Rohm Semiconductor
Category	Integrated Circuits (ICs)
	Memory
Package	8-SOIC (0.154", 3.90mm Width)
Series	-
Memory Type	Non-Volatile
Memory Format	EEPROM
Technology	EEPROM
Memory Size	128Kb (16K x 8)
Memory Interface	SPI
Clock Frequency	20MHz
Write Cycle Time - Word, Page	5ms
Access Time	-
Voltage - Supply	1.6 V ~ 5.5 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.154", 3.90mm Width)
Supplier Device Package	8-SOP-J
	Report errors?

BR25G128FJ-3GE2 Guarantees

Quality Guarantees
We provide 90 days warranty. *
If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

Service Guarantees
We guarantee 100% customer satisfaction.
Our experienced sales team and tech support team back our services to satisfy all our customers.

BR25G128FJ-3GE2 Payment Methods

BR25G128FJ-3GE2 Shipping Methods

If you have any question about BR25G128FJ-3GE2, please do not hesitate to contact us!
Website: https://www.heisener.com
E-mail: salesdept@heisener.com